

Product/Process Change Notice - PCN 09_0146 Rev. -

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This notice is to inform you of a change that will be made to certain ADI products (see Material Report). Any issues with this PCN or requirements to qualify the change (additional data or samples) must be sent to ADI within 30 days of publication date. ADI contact information is listed below.

PCN Title: Die revision of the AD8250, AD8251 and the AD8253 to include Polyimide coating

Publication Date: 11-Sep-2009 Samples Available Date: 30-Nov-2009

Effectivity Date: 10-Dec-2009 (the earliest date that a customer could expect to receive changed material)

Description Of Change

Polyimide overcoat layer to be implemented for the wafer fabrication process of the AD8250, AD8251 and the AD8253. Electrical performance (per datasheet) is not affected by this change.

Reason For Change

Vos, Gain and CMRR performance of the AD8250, AD8251 and the AD8253 has been related to package stress sensitivity. Addition of the polyimide layer reduces this sensitivity to package stress and gives flexibility in choosing package materials.

Impact of the change (positive or negative) on fit, form, function & reliability

The addition of Polyimide material will not affect the fit, form, or function that would be seen by the end-user. The performance of the part will continue to match the specifications in the datasheet.

Summary of Supporting Information

Qualification has been performed per Analog Devices specification ADI0012. See attached qualification data.

Supporting Documents

Attachment 1: ADI_PCN_09_0146_Rev_-_Polyimide Qual Data.doc

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| Appendix A - Affected ADI Models | | | | | | |
|---|------------------------|------------------------|------------------------|-----------------------|------------------------|--|
| Added Parts On This Revision - Product Family / Model Number (14) | | | | | | |
| AD8250 / AD8250-EVALZ | AD8250 / AD8250ARMZ | AD8250 / AD8250ARMZ-R7 | AD8250 / AD8250ARMZ-RL | AD8251 / AD8251-EVALZ | AD8251 / AD8251ARMZ | |
| AD8251 / AD8251ARMZ-R7 | AD8251 / AD8251ARMZ-RL | AD8253 / AD8253-EVALZ | AD8253 / AD8253ARMZ | AD8253 / AD8253ARMZ-C | AD8253 / AD8253ARMZ-R7 | |
| AD8253 / AD8253ARMZ-R7-C | AD8253 / AD8253ARMZ-RL | | | | | |

| Appendix B - Revision History | | | | |
|-------------------------------|--------------|--|--|--|
| Rev | Publish Date | Rev Description | | |
| Rev | 11-Sep-2009 | Die revision of the AD8250, AD8251 and the AD8253 to include Polyimide coating | | |

Analog Devices, Inc.

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